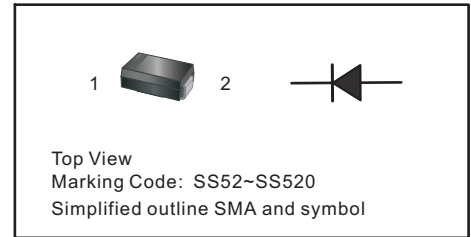




Surface Mount Schottky Barrier Rectifier
Reverse Voltage - 20 to 200 V
Forward Current - 5.0A

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode


Features

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

MECHANICAL DATA

- Case: SMA
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 60mg / 0.0021oz

Absolute Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %

Parameter	Symbols	SS52	SS54	SS56	SS58	SS510	SS512	SS515	SS520	Units
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	20	40	60	80	100	120	150	200	V
Maximum RMS voltage	V _{RMS}	14	28	42	56	70	84	105	140	V
Maximum DC Blocking Voltage	V _{DC}	20	40	60	80	100	120	150	200	V
Maximum Average Forward Rectified Current	I _{F(AV)}	5.0								A
Peak Forward Surge Current,8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	100								A
Max Instantaneous Forward Voltage at 5 A	V _F	0.55	0.70		0.85			0.90	V	
Maximum DC Reverse Current T _a = 25°C at Rated DC Reverse Voltage T _a =100°C	I _R	0.5 10								mA
Typical Junction Capacitance ⁽¹⁾	C _j	500	300							pF
Typical Thermal Resistance ⁽²⁾	R _{θJA}	60								°C/W
Operating Junction Temperature Range	T _j	-55 ~ +150								°C
Storage Temperature Range	T _{stg}	-55 ~ +150								°C

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.



Fig.1 Forward Current Derating Curve

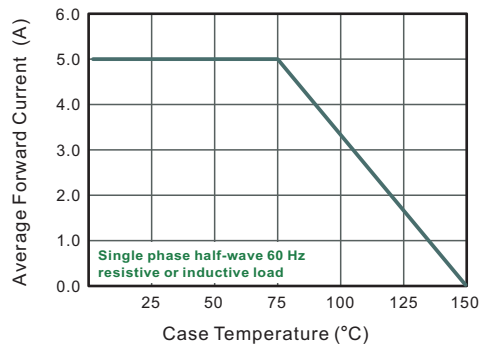


Fig.2 Typical Reverse Characteristics

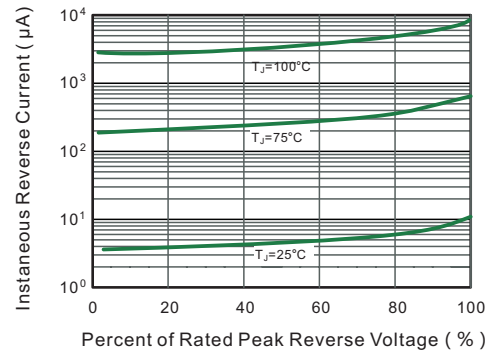


Fig.3 Typical Forward Characteristic

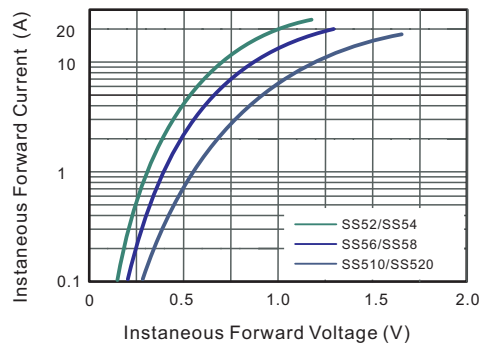


Fig.4 Typical Junction Capacitance

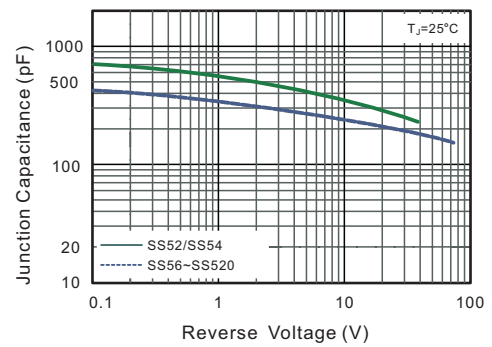


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

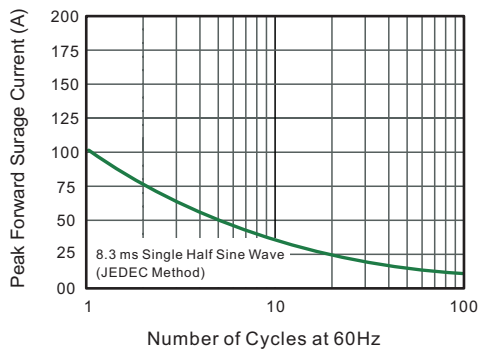
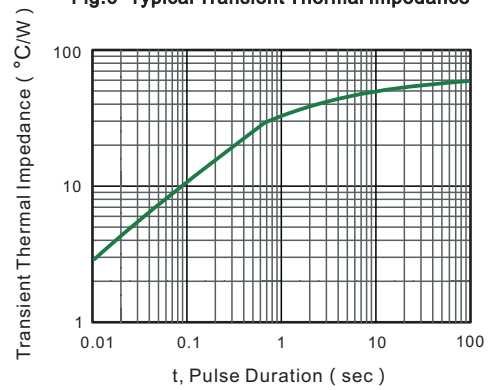


Fig.6- Typical Transient Thermal Impedance

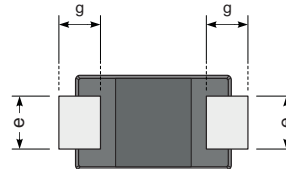
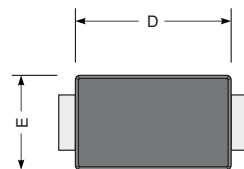
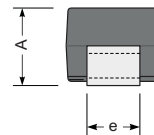
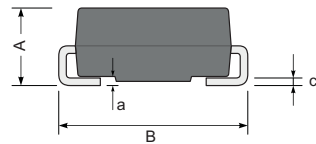




PACKAGE OUTLINE

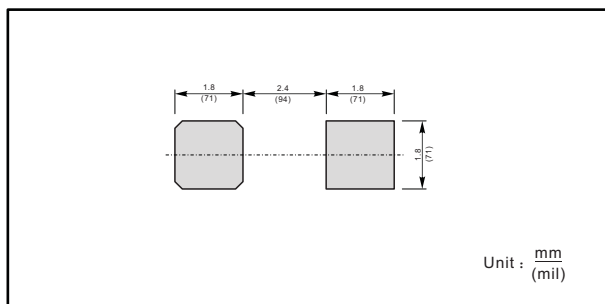
Plastic surface mounted package; 2 leads

SMA



UNIT		A	D	E	B	c	e	g	a
mm	max	2.2	4.5	2.8	5.3	0.31	1.6	1.5	0.3
	min	1.9	4.0	2.4	4.8	0.15	1.3	0.9	
mil	max	87	181	110	209	12	63	59	12
	min	75	157	94	189	6	51	35	

The recommended mounting pad size



Marking

Type number	Marking code
SS52	SS52
SS54	SS54
SS56	SS56
SS58	SS58
SS510	SS510
SS512	SS512
SS515	SS515
SS520	SS520